



PMZB220VPE

12 V, P-channel Trench MOSFET

16 June 2025

Product data sheet

1. General description

P-channel enhancement mode Field-Effect Transistor (FET) in a leadless ultra small DFN1006B-3 (SOT883B) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

2. Features and benefits

- Very low threshold voltage
- Very fast switching
- Trench MOSFET technology
- ElectroStatic Discharge (ESD) protection typically > 2 kV
- Ultra thin package profile of 0.37 mm

3. Applications

- Relay driver
- High-speed line driver
- High-side load switch
- Switching circuits

4. Quick reference data

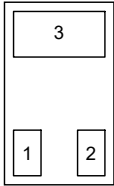
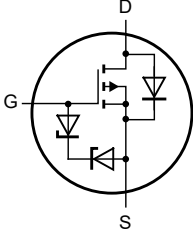
Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
V_{DS}	drain-source voltage	$T_j = 25\text{ °C}$		-	-	-12	V
V_{GS}	gate-source voltage			-6	-	6	V
I_D	drain current	$V_{GS} = -4.5\text{ V}; T_{amb} = 25\text{ °C}$	[1]	-	-	-1.2	A
Static characteristics							
R_{DSon}	drain-source on-state resistance	$V_{GS} = -4.5\text{ V}; I_D = -1.2\text{ A}; T_j = 25\text{ °C}$		-	300	355	mΩ
		$V_{GS} = -1.8\text{ V}; I_D = -0.1\text{ A}; T_j = 25\text{ °C}$		-	540	820	mΩ

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 1 cm².

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate	 Transparent top view DFN1006B-3 (SOT883B)	 017aaa259
2	S	source		
3	D	drain		

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PMZB220VPE	DFN1006B-3	plastic, leadless ultra small plastic package; 3 solder lands; 0.35 mm pitch; 1.0 mm x 0.6 mm x 0.37 mm body	SOT883B

7. Marking

Table 4. Marking codes

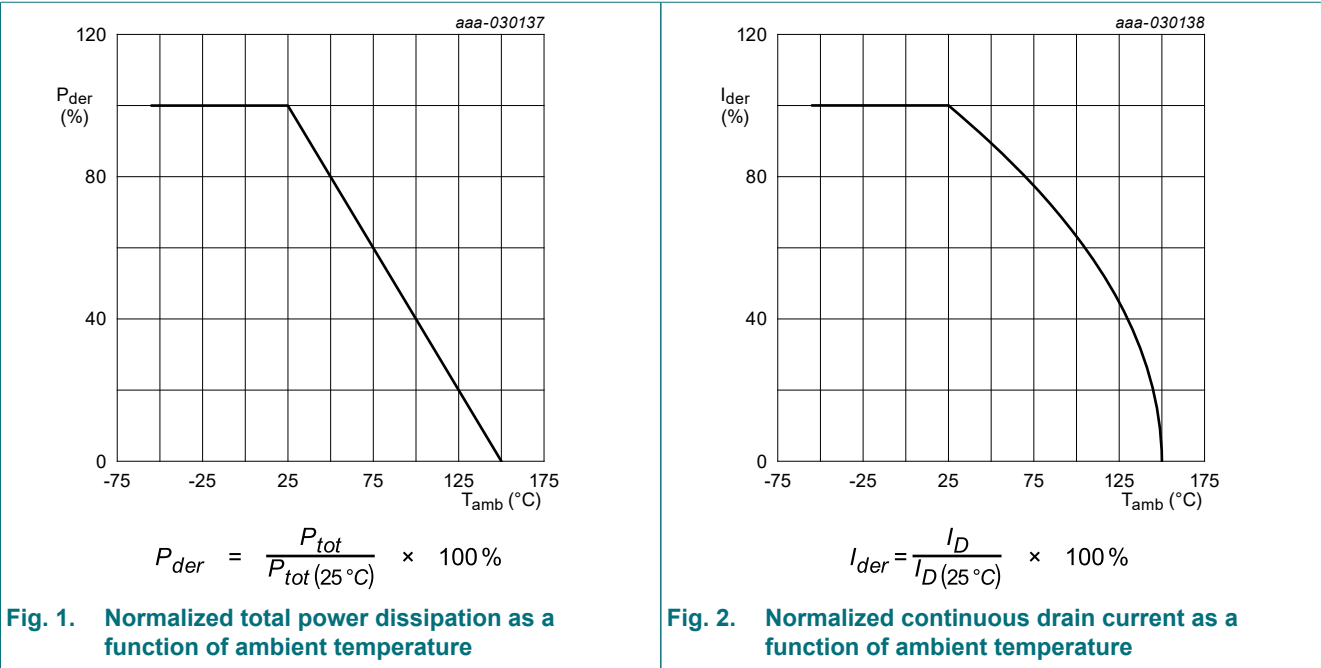
Type number	Marking code
PMZB220VPE	1001 1101

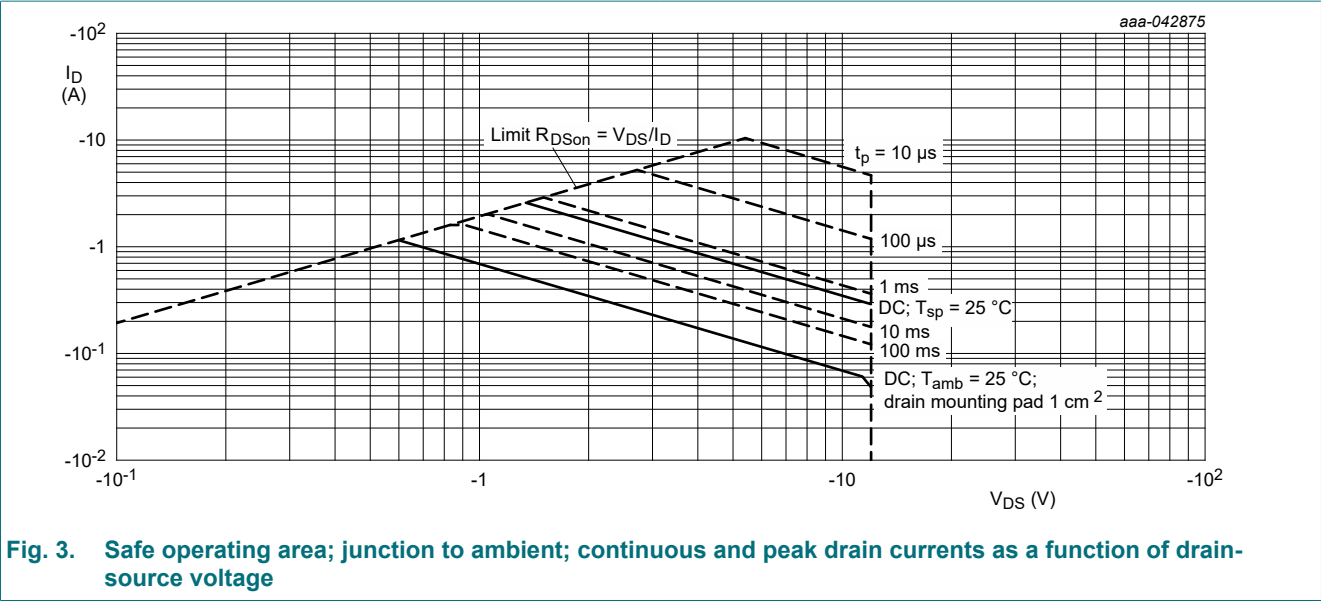
8. Limiting values

Table 5. Limiting values
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{DS}	drain-source voltage	T _j = 25 °C		-	-12	V
V _{GS}	gate-source voltage			-6	6	V
I _D	drain current	V _{GS} = -4.5 V; T _{amb} = 25 °C	[1]	-	-1.2	A
I _{DM}	peak drain current	T _{amb} = 25 °C; single pulse; t _p ≤ 10 μs		-	-10.4	A
P _{tot}	total power dissipation	T _{amb} = 25 °C	[2]	-	340	mW
			[1]	-	690	mW
		T _{sp} = 25 °C		-	3.5	W
T _j	junction temperature			-55	150	°C
T _{amb}	ambient temperature			-55	150	°C
T _{stg}	storage temperature			-65	150	°C
Source-drain diode						
I _S	source current	T _{amb} = 25 °C	[1]	-	-0.63	A

- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 1 cm².
 [2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.





9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1]	-	315	363	K/W
			[2]	-	157	181	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point			-	29	36	K/W

- [1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 1 cm².

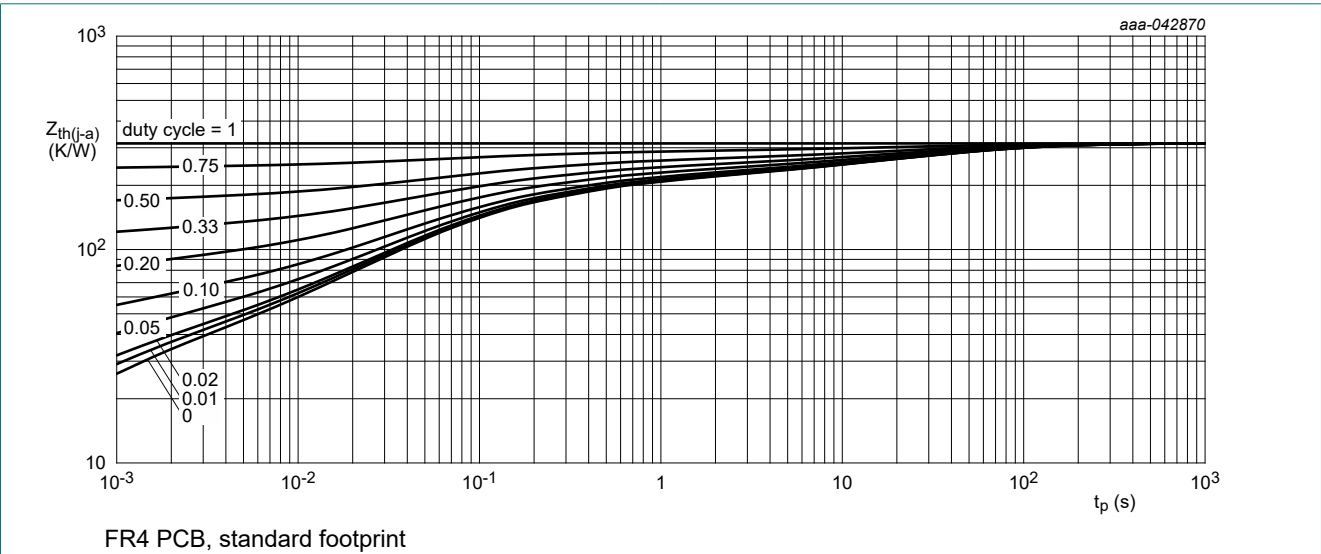


Fig. 4. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

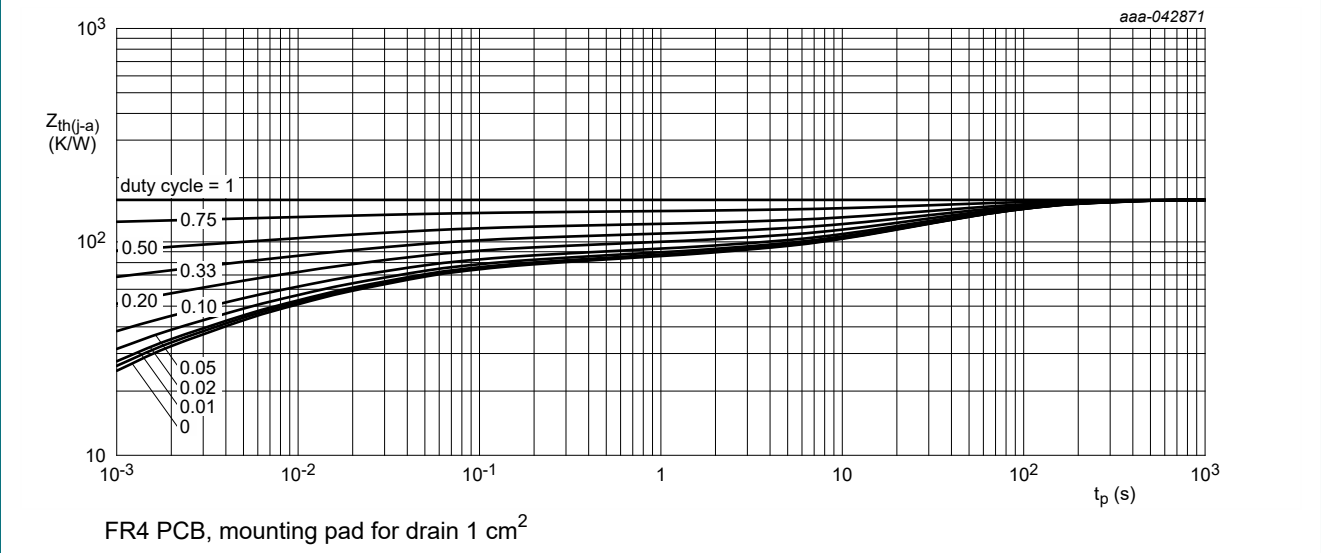


Fig. 5. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
Static characteristics							
V _{(BR)DSS}	drain-source breakdown voltage	I _D = -250 μA; V _{GS} = 0 V; T _j = 25 °C		-12	-	-	V
V _{GStH}	gate-source threshold voltage	I _D = -250 μA; V _{DS} =V _{GS} ; T _j = 25 °C		-0.35	-0.57	-0.83	V
I _{DSS}	drain leakage current	V _{DS} = -10 V; V _{GS} = 0 V; T _j = 25 °C		-	-	-1	μA
I _{GSS}	gate leakage current	V _{GS} = -6 V; V _{DS} = 0 V; T _j = 25 °C		-	-	-10	μA
		V _{GS} = 6 V; V _{DS} = 0 V; T _j = 25 °C		-	-	10	μA
		V _{GS} = -4.5 V; V _{DS} = 0 V; T _j = 25 °C		-	-	-1.5	μA
		V _{GS} = 4.5 V; V _{DS} = 0 V; T _j = 25 °C		-	-	1.5	μA
		V _{GS} = -2.5 V; V _{DS} = 0 V; T _j = 25 °C		-	-	-500	nA
		V _{GS} = 2.5 V; V _{DS} = 0 V; T _j = 25 °C		-	-	500	nA
R _{DSon}	drain-source on-state resistance	V _{GS} = -4.5 V; I _D = -1.2 A; T _j = 25 °C		-	300	355	mΩ
		V _{GS} = -4.5 V; I _D = -1.2 A; T _j = 150 °C		-	440	520	mΩ
		V _{GS} = -2.5 V; I _D = -1 A; T _j = 25 °C		-	430	600	mΩ
		V _{GS} = -1.8 V; I _D = -0.1 A; T _j = 25 °C		-	540	820	mΩ
		V _{GS} = -1.5 V; I _D = -0.01 A; T _j = 25 °C		-	630	1400	mΩ
g _{fs}	forward transconductance	V _{DS} = -5 V; I _D = -1.2 A; T _j = 25 °C		-	1.9	-	S
Dynamic characteristics							
Q _{G(tot)}	total gate charge	V _{DS} = -6 V; I _D = -1.2 A; V _{GS} = -4.5 V; T _j = 25 °C		-	0.9	1.4	nC
Q _{GS}	gate-source charge			-	0.1	-	nC
Q _{GD}	gate-drain charge			-	0.3	-	nC
C _{iSS}	input capacitance	V _{DS} = -6 V; f = 1 MHz; V _{GS} = 0 V; T _j = 25 °C		-	67.8	-	pF
C _{oSS}	output capacitance			-	20.1	-	pF
C _{rSS}	reverse transfer capacitance			-	17.7	-	pF
t _{d(on)}	turn-on delay time	V _{DS} = -6 V; I _D = -1.2 A; V _{GS} = -4.5 V; R _{G(ext)} = 6 Ω; T _j = 25 °C		-	1	-	ns
t _r	rise time			-	4	-	ns
t _{d(off)}	turn-off delay time			-	8	-	ns
t _f	fall time			-	6	-	ns
Source-drain diode							
V _{SD}	source-drain voltage	I _S = -0.52 A; V _{GS} = 0 V; T _j = 25 °C		-	-0.7	-1.2	V

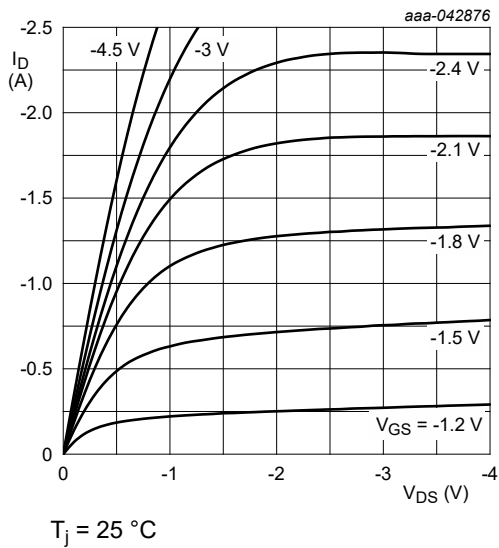


Fig. 6. Output characteristics: drain current as a function of drain-source voltage; typical values

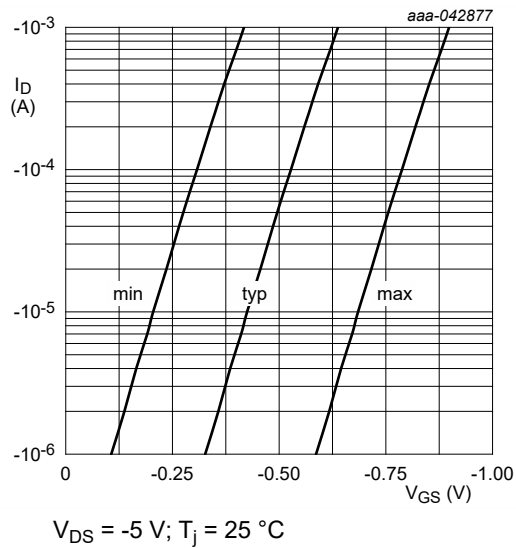


Fig. 7. Sub-threshold drain current as a function of gate-source voltage

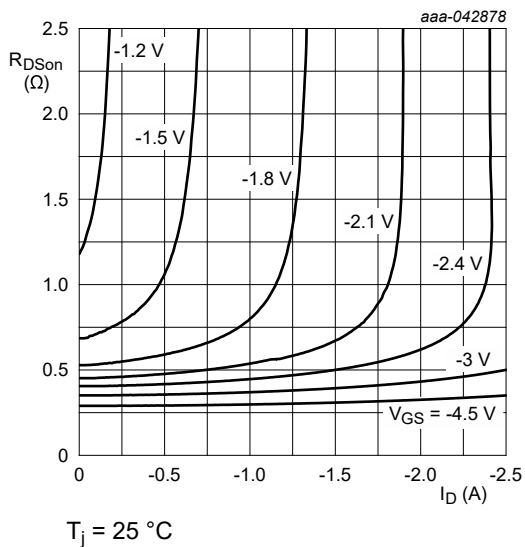


Fig. 8. Drain-source on-state resistance as a function of drain current; typical values

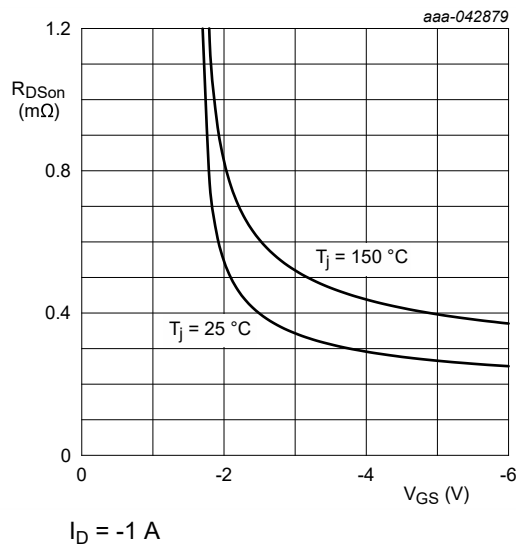


Fig. 9. Drain-source on-state resistance as a function of gate-source voltage; typical values

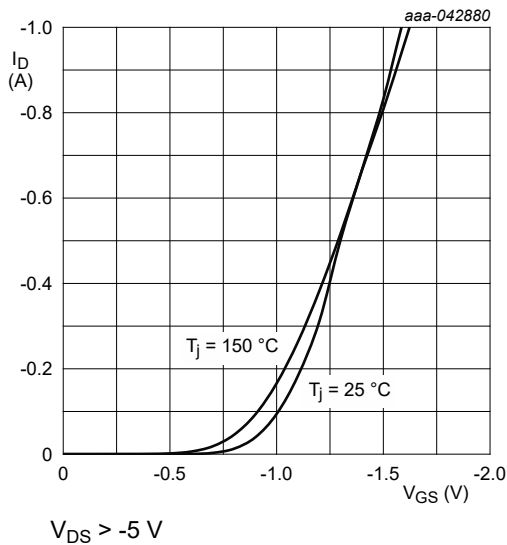


Fig. 10. Transfer characteristics: drain current as a function of gate-source voltage; typical values

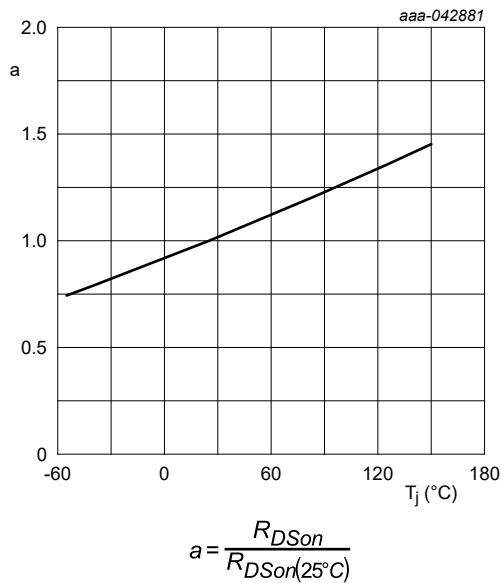


Fig. 11. Normalized drain-source on-state resistance as a function of junction temperature; typical values

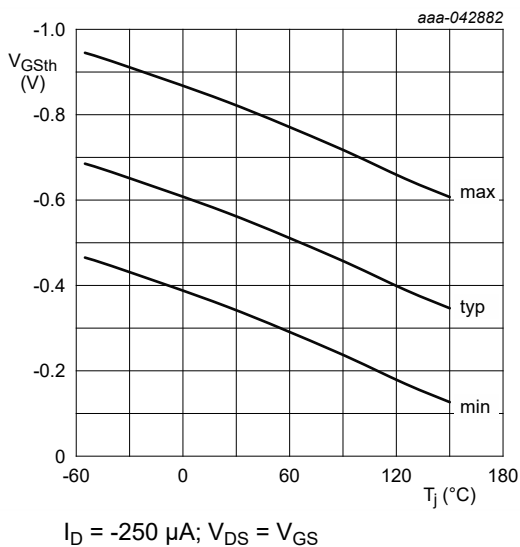


Fig. 12. Gate-source threshold voltage as a function of junction temperature

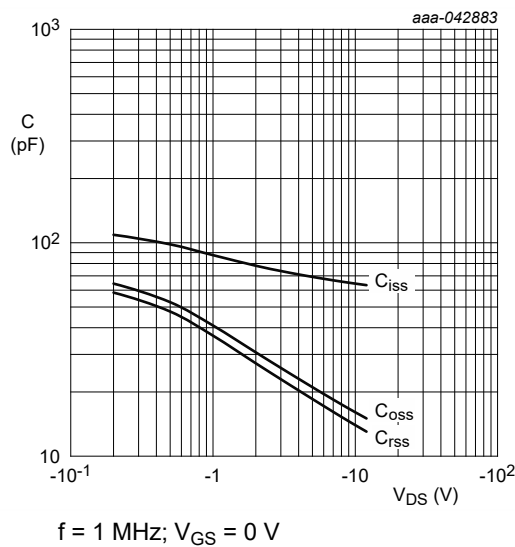


Fig. 13. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values

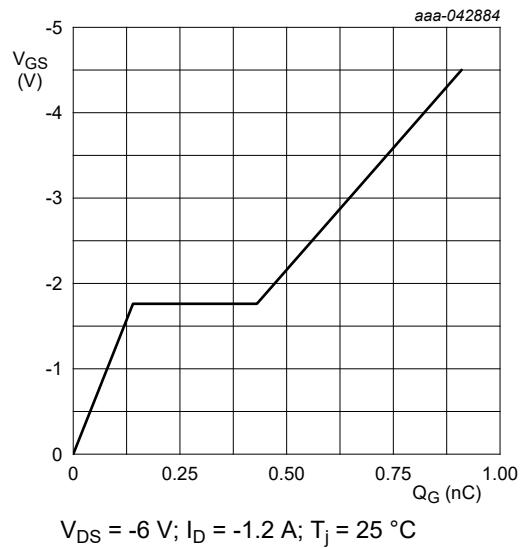


Fig. 14. Gate-source voltage as a function of gate charge; typical values

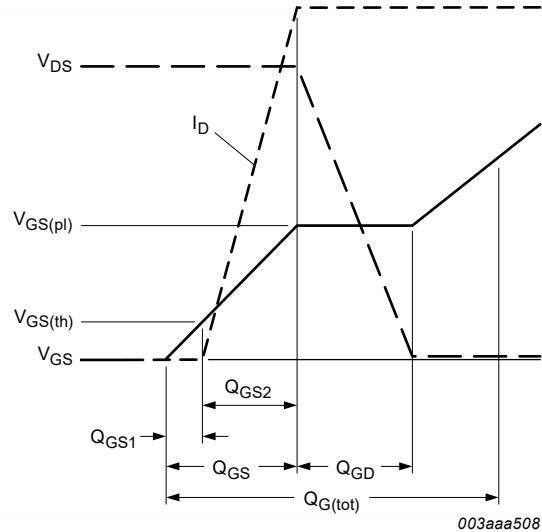


Fig. 15. Gate charge waveform definitions

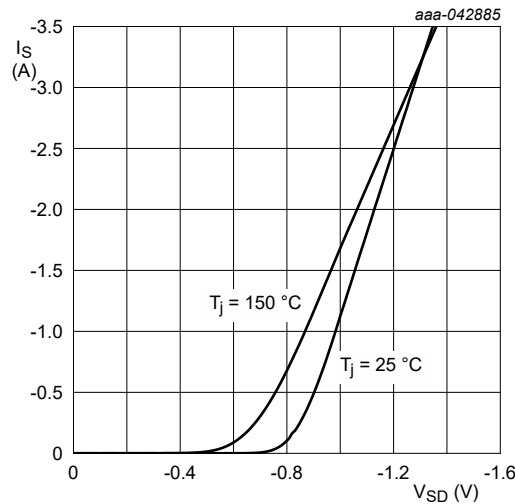


Fig. 16. Source current as a function of source-drain voltage; typical values

11. Test information

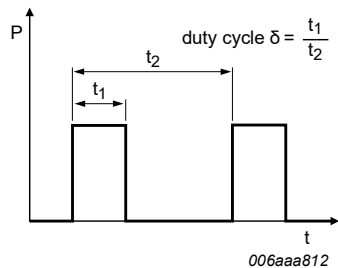


Fig. 17. Duty cycle definition

12. Package outline

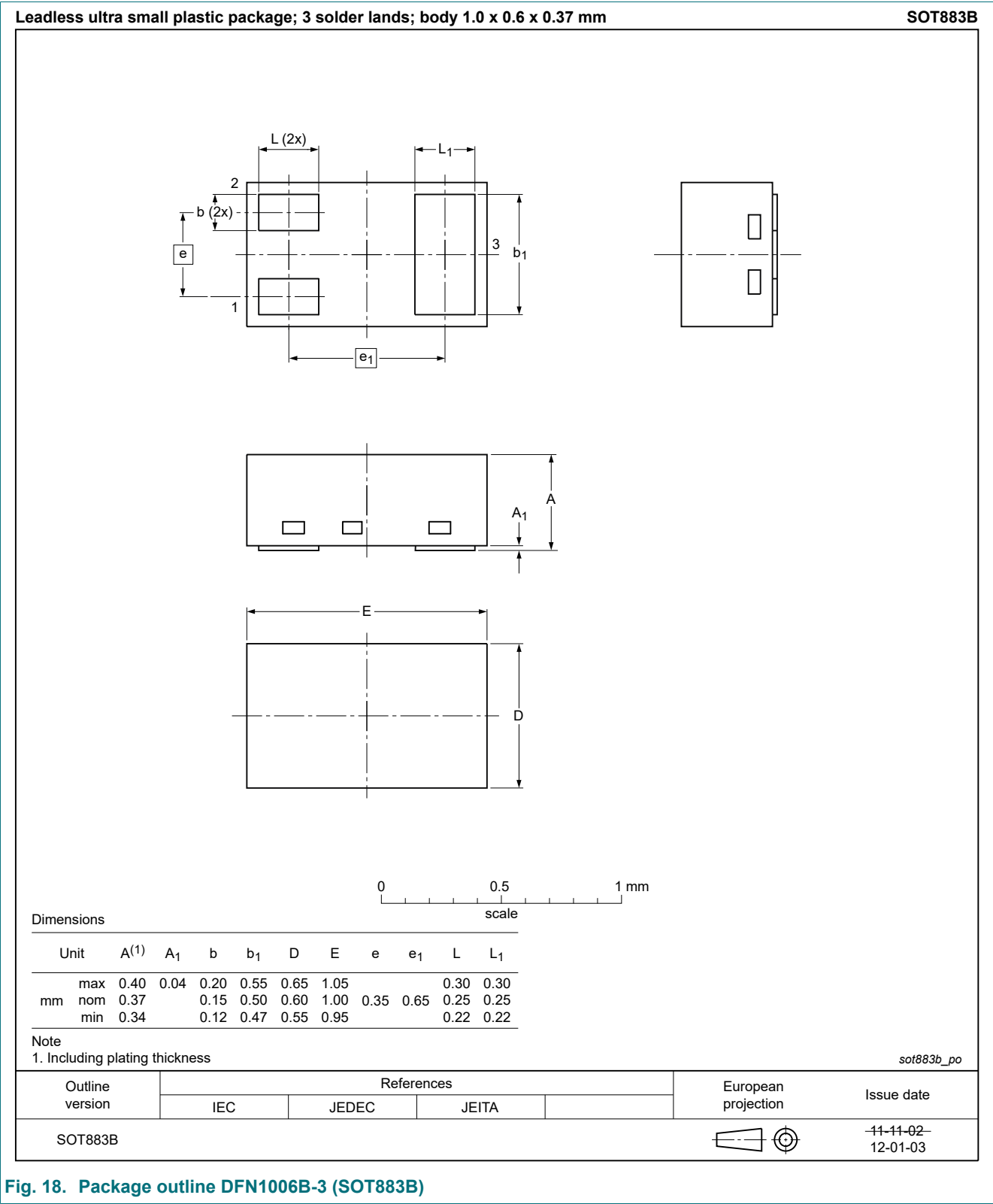
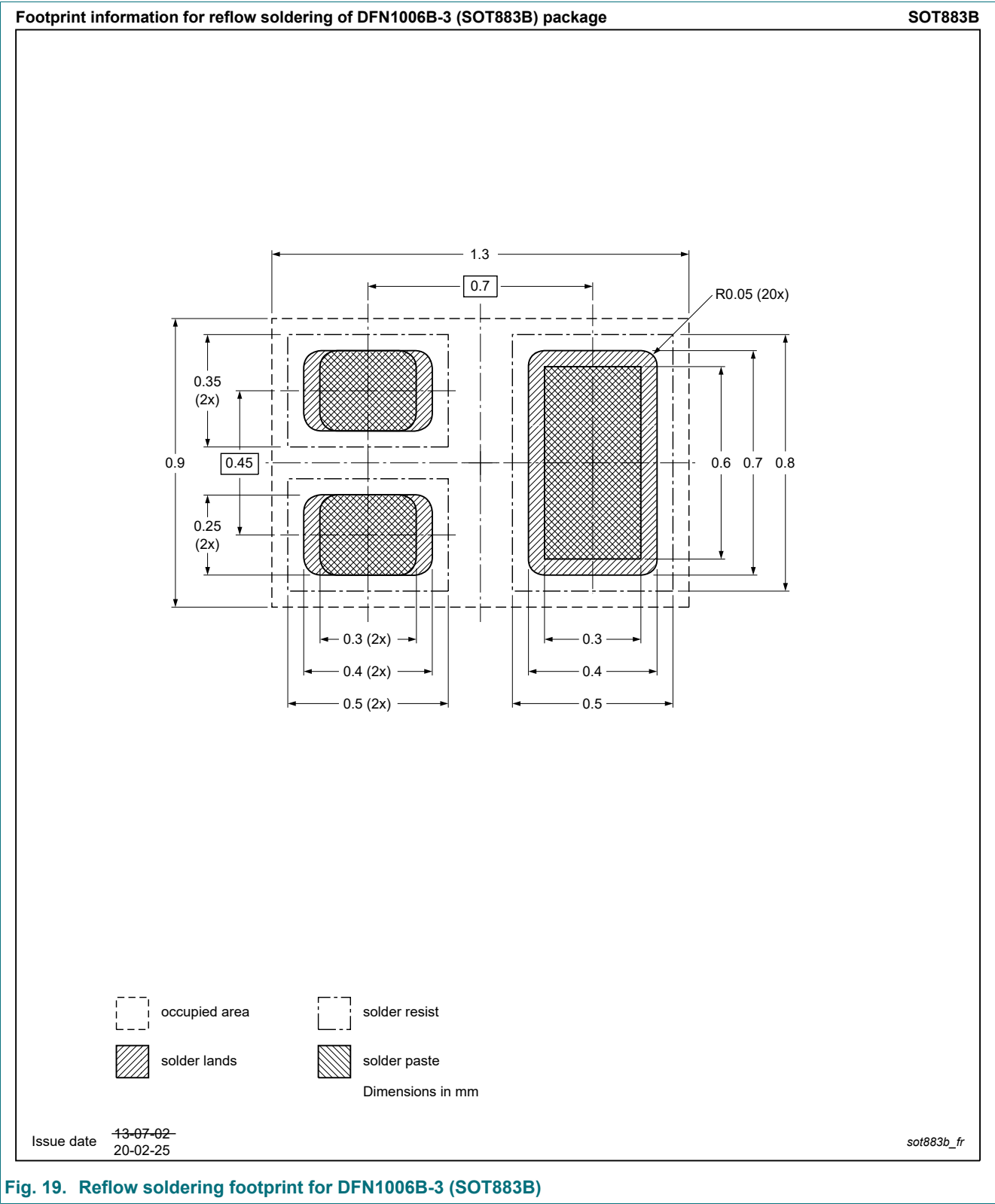


Fig. 18. Package outline DFN1006B-3 (SOT883B)

13. Soldering



14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PMZB220VPE v.1	20250616	Product data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Product [short] data sheet	Production	This document contains the product specification.

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